
**COMPLETION OF JAPAN REFINANCING
- SERIES 3 TMK BONDS**

1. INTRODUCTION

The Board of Directors (the "**Board**") of OUE Lippo Healthcare Limited (the "**Company**") and together with its subsidiaries, the "**Group**") refers to the announcement dated 27 May 2020 ("**Earlier Refinancing Announcement**") in relation to the proposed subscription by Shinsei Bank Limited of JPY 11.0 billion of new Japan TMK Bonds (the "**Series 3 TMK Bonds**") issued by OUELH Japan First TMK, an indirect wholly owned subsidiary of the Company.

Capitalised terms used herein shall have the definitions ascribed to them in the Earlier Refinancing Announcement, unless otherwise stated or the context otherwise requires.

2. COMPLETION OF THE SUBSCRIPTION OF SERIES 3 TMK BONDS

Further to the Earlier Refinancing Announcement, the Board is pleased to announce that the subscription of the Series 3 TMK Bonds by Shinsei Bank has been completed today.

By Order of the Board
OUE Lippo Healthcare Limited

Mr. Yet Kum Meng
Chief Executive Officer and Executive Director
29 May 2020

*This announcement has been prepared by the Company and its contents have been reviewed by the Company's sponsor, PrimePartners Corporate Finance Pte. Ltd. (the "**Sponsor**"), in accordance with Rules 226(2)(b) and 753(2) of the Singapore Exchange Securities Trading Limited (the "**SGX-ST**") Listing Manual Section B: Rules of Catalyst.*

This announcement has not been examined or approved by the SGX-ST. The SGX-ST assumes no responsibility for the contents of this announcement, including the correctness of any of the statements or opinions made or reports contained in this announcement.

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